

STACKUP TABLE:

Layer	Name	Material	Thickness	Constant	Board Layer Stack
1	Top Overlay	Solder Resist	0.80mil	3.5	
2	Top Solder	Solder Resist	0.80mil	3.5	
3	L1 TOP	Copper	1.60mil		
4	Dielectric 1	R03003	5.00mil	3	
5	L2 GND	Copper	0.80mil		
6	Dielectric2	R04450F	3.62mil	3.52	
7	L3 SIGNAL 1	Copper	0.60mil		
8	Dielectric3	R04835 LOPRO	10.70mil	3.66	
9	L4 GND	Copper	0.60mil		
10	Dielectric4	370HR	8.02mil	4.02	
11	L5 SIGNAL 2	Copper	1.20mil		
12	Dielectric5	370HR	10.00mil	4.34	
13	L6 SIGNAL 3	Copper	0.60mil		
14	Dielectric6	370HR	4.52mil	4.06	
15	L7 GND	Copper	0.80mil		
16	Dielectric7	370HR	5.00mil	4.34	
17	L8 BOTTOM	Copper	1.60mil		
18	Bottom Solder	Solder Resist	0.80mil	3.5	
19	Bottom Overlay				

THIS IS AN IMPEDANCE CONTROLLED BOARD

NOTE:

1. EXTERNAL LAYER CU THICKNESS ARE FINISHED THICKNESS AFTER PLATING.

NOTES: UNLESS OTHERWISE SPECIFIED.

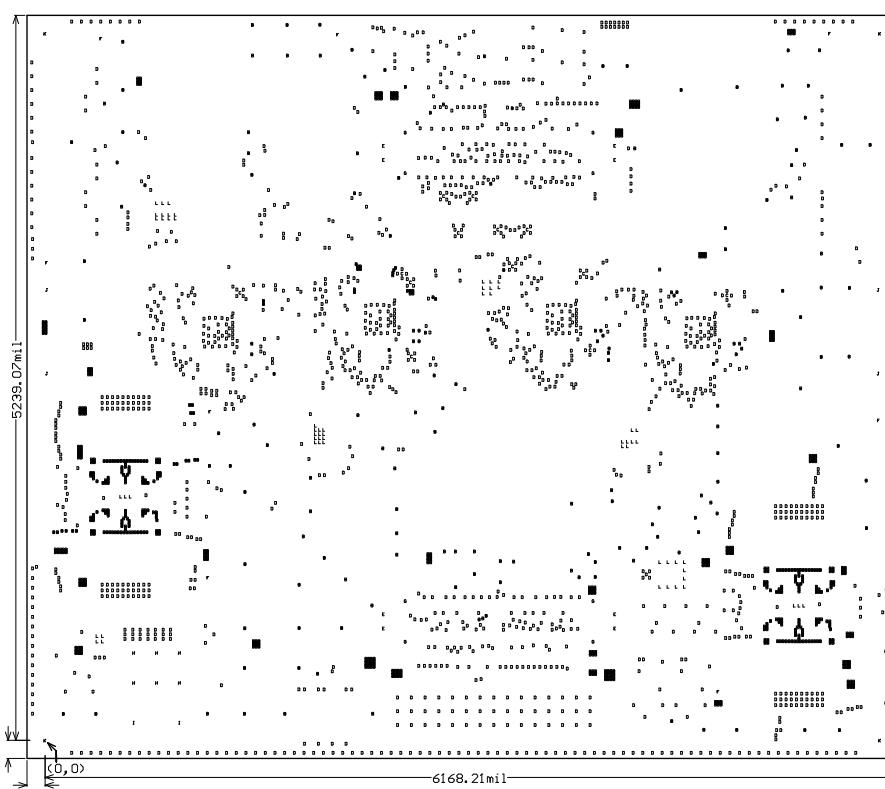
- ALL VIAS ARE TENTED ON BOTH SIDES UNLESS SOLDERMASK OPENED IN GERBER.
- THE SOLDER MASK IMAGES THAT ARE THE SAME SIZE AS THE COMPONENT PADS MAY BE ENLARGED AS PER THE MANUFACTURING CAPABILITIES BUT NOT BEYOND 0.08MM PER SIDE OR 0.15MM OVERALL. ALL OTHER SOLDER MASK IMAGES SHALL NOT BE MODIFIED.
- TRACE WIDTH SHOULD BE ACCURATELY ETCHED. MAX TOLERANCE +/- 1 MIL FOR ETCHING ACCURACY NEAR THE ANTENNA REFER "ANTENNAETCHING_REQUIREMENTS" DOCUMENT
- 5.9MIL VIA ONLY ON PAD SHOULD BE FILLED WITH CONDUCTIVE COPPER AND SURFACE SHOULD BE FLAT. FLATNESS TOLERANCE FOR VIA ON PADS: +0.000 /- 0.001 INCHES ON TOP SIDE.
- BACKDRILLING INFO: 12 MIL DRILL AND 24 MIL PAD NEED TO BE REMOVED FROM THE BOTTOM TO LAYER 4 USE 24MIL DRILL BIT FOR BACKDRILLING ABOVE MENTIONED DRILLS. VENDOR MUST CUT L4 AND MUST NOT CUT L3.
- PRINTED WIRING BOARD SHALL COMPLY WITH REQUIREMENTS OF ANSI/J-STD-003.
- BOW AND TWIST SHALL NOT EXCEED 0.7% OF LONGEST SIDE

IMPEDANCE TABLE

LAYER	TRACE WIDTH (mil)	TRACE SPACING (mil)	IMPEDANCE
1	10.5	-	50 OHM +/-10%
1	6.5	5.5	100 OHM +/-10%
3	5.1	-	50 OHM +/-10%
5	12	-	50 OHM +/-10%
6	6.9	-	50 OHM +/-10%
6	5	7	100 OHM +/-10%
8	7.75	-	50 OHM +/-10%
8	5.25	6.75	100 OHM +/-10%

Symbol	Count	Hole Size	Drill Layer Pair	Plated	Hole Tolerance(mil)
L	60	7.87mil (0.200mm)	L1 TOP - L8 BOTTOM	PTH	+0/-7.87
B	727	8.00mil (0.203mm)	L1 TOP - L8 BOTTOM	PTH	+0/-8
C	13	12.00mil (0.305mm)	L1 TOP - L8 BOTTOM	PTH	+0/-12
D	1522	12.20mil (0.310mm)	L1 TOP - L8 BOTTOM	PTH	+0/-12.2
E	8	39.37mil (<1.000mm)	L1 TOP - L8 BOTTOM	PTH	+4/-0
F	8	40.00mil (<1.016mm)	L1 TOP - L8 BOTTOM	PTH	+/-3
G	8	47.24mil (<1.200mm)	L1 TOP - L8 BOTTOM	PTH	+4/-0
H	6	70.87mil (<1.800mm)	L1 TOP - L8 BOTTOM	PTH	+/-2
I	2	118.11mil (<3.000mm)	L1 TOP - L8 BOTTOM	NPTH	+/-2
J	4	118.11mil (<3.000mm)	L1 TOP - L8 BOTTOM	PTH	+/-3
K	4	160.00mil (<4.064mm)	L1 TOP - L8 BOTTOM	PTH	+/-3
2362 Total					

DRILL TABLE: (L1-L8)



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PROCO54	REV: C	SUN REV: Not In VersionControl
LAYER NAME = FAB1			
GENERATED : 10/22/2018 12:41:46 PM	TEXAS INSTRUMENTS		

Texas Instruments (TI) and/or its licensors do not warrant the accuracy or completeness of this specification or any information contained therein. TI and/or its licensors do not warrant that this design will meet the specifications, will be suitable for your application or fit for any particular purpose, or will operate in an implementation. TI and/or its licensors do not warrant that the design is production worthy. You should completely validate and test your design implementation to confirm the system functionality for your application.

DESIGN INFORMATION	
MIN. TRACK WIDTH:	<input type="checkbox"/> 4 mil
MIN. CLEARANCE:	<input type="checkbox"/> 4 mil
MIN. VIA PAD SIZE:	<input type="checkbox"/> 13.77 mil
MINIMUM ANNULAR RING 0.05mm (2ML) EXTERNAL PER PC-D-275 CLASS 2 LEVEL C	
REGISTRATION TOLERANCES: METAL +/- .2 MIL HOLES +/- .3 MIL HOLE SIZE TOLERANCE (UNLESS OTHERWISE SPECIFIED): +/- .3 MIL	
MATERIAL:	
<input type="checkbox"/> FR-408	<input type="checkbox"/> FR-4 High Tg <input checked="" type="checkbox"/> OTHER REFER STACKUP
<input type="checkbox"/> 62 mil (1.6mm) +/-10%	<input checked="" type="checkbox"/> OTHER 55mil +/-10%
TOLERANCE:	
<input type="checkbox"/> OTHER +/-	
BOW & TWIST:	
<input type="checkbox"/> ANSI IPC-6012 TYPE 3 CLASS 2	<input checked="" type="checkbox"/> OTHER +/- REFER NOTE [7]
DRILLING:	
<input checked="" type="checkbox"/> AS SHOWN	<input type="checkbox"/> NC_DRILL FILES
PTH COPPER THICKNESS: <input type="checkbox"/> 20-30 um <input type="checkbox"/> OTHER	
BOARD FINISH:	
<input type="checkbox"/> SILKSCREEN:	<input checked="" type="checkbox"/> TOP <input type="checkbox"/> BOTTOM
<input type="checkbox"/> SILKSCREEN COLOR:	<input checked="" type="checkbox"/> WHITE <input type="checkbox"/> OTHER
<input type="checkbox"/> SOLDER RESIST COLOR:	<input type="checkbox"/> GREEN <input checked="" type="checkbox"/> OTHER RED
<input type="checkbox"/> MATTE	<input type="checkbox"/> SEMI-GLOSS
SURFACE FINISH:	
<input type="checkbox"/> IMMERSION GOLD (ENG)	<input type="checkbox"/> ENEPIC
<input checked="" type="checkbox"/> IMM. TIN/SILVER OR EQUIV	<input type="checkbox"/> OTHER
ARRAY/PANEL:	
<input type="checkbox"/> CUT AND TRIM PER M1 BOARD OUTLINE	
<input type="checkbox"/> N.C. ROUTE	<input type="checkbox"/> V. SCORE
CERTIFICATION:	
MATERIALS AND WORKMANSHIP FOR ALL PCBs TO MEET OR EXCEED THE REQUIREMENTS OF:	
<input checked="" type="checkbox"/> ANSI IPC-A-600F CLASS ->	<input type="checkbox"/> 1 <input checked="" type="checkbox"/> 2 <input type="checkbox"/> 3
<input type="checkbox"/> RoHS	<input type="checkbox"/> OTHER PER ORDER
ALL BOARDS MUST MEET OR EXCEED UL94-V0 REQUIREMENTS.	
PCB MUST BEAR THE UL94-V-0 UL REGISTERED MATERIAL ID NUMBER	
ADDITIONAL REQUIREMENTS:	
<input type="checkbox"/> YES	
BARE BOARD ELEC. TEST: <input type="checkbox"/> NONE <input checked="" type="checkbox"/> REQUIRED <input type="checkbox"/> PER ORDER	
<input type="checkbox"/> XX MIL VIAS REQUIRE NON-CONDUCTIVE FILL AND PLANARIZE	
<input type="checkbox"/> XX MIL VIAS REQUIRE CONDUCTIVE FILL AND PLANARIZE	
<input type="checkbox"/> OUTER XX MIL TRACES REQUIRE 50 OHM SINGLE-ENDED IMPEDANCE LAYER 2 & 3 (INNER LAYERS) XX MIL WIDE, XX MIL SPACE	
<input type="checkbox"/> TRACES REQUIRE 100 OHM DIFFERENTIAL IMPEDANCE	

TEXAS
INSTRUMENTS

PROJECT TITLE:	MMW_CAS_RF_EUM
DESIGNED FOR:	Public Release
FILE NAME:	PROCO54C_MMWCAS_RF_EUM.PcbDoc

ENGINEER:	LAYOUT BY:
a0221760	Tessolve
SCALE: 0.72	ALUM DESIGNER VERSION: 17.1.9.592

